

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	2604	chip adj scale adj package	US-PGPUB; USPAT
2	BRS	L2	38	L1 and (metal adj substrate) and (hole or aperture or opening)	US-PGPUB; USPAT
3	BRS	L3	909	257/713.ccls.	US-PGPUB; USPAT
4	BRS	L4	15	L3 and (metal adj substrate) and (hole or aperture or opening)	US-PGPUB; USPAT
5	BRS	L5	87	BGA and (metal adj substrate) and (hole or aperture or opening) and wire	US-PGPUB; USPAT
6	BRS	L6	1816	257/774.ccls.	US-PGPUB; USPAT
7	BRS	L7	22	L6 and (metal adj substrate) and (hole or aperture or opening)	US-PGPUB; USPAT
8	BRS	L8	1608	257/787.ccls.	US-PGPUB; USPAT
9	BRS	L9	1905	257/666.ccls.	US-PGPUB; USPAT
10	BRS	L10	651	L9 and wire and (hole or aperture or opening)	US-PGPUB; USPAT
11	BRS	L11	33	L10 and leadless	US-PGPUB; USPAT
12	BRS	L12	36	leadless and (metal adj substrate) and (hole or aperture or opening)	US-PGPUB; USPAT
13	BRS	L13	1	"4698662".PN.	USPAT; USOCR
14	BRS	L14	1	"4544989".PN.	USPAT; USOCR
15	BRS	L15	1	"4509096".PN.	USPAT; USOCR
16	BRS	L16	1	"4396936".PN.	USPAT; USOCR

17	BRS	L17	1	"4222516".PN.	USPAT; USOCR
18	BRS	L18	1	"4218701".PN.	USPAT; USOCR

	Type	L #	Hits	Search Text	DBs
19	BRS	L19	1	"4150393".PN.	USPAT; USOCR
20	BRS	L20	173	257/708.ccls.	US-PGPUB; USPAT
21	BRS	L21	1039	257/780.ccls.	US-PGPUB; USPAT
22	BRS	L22	1324	257/676.ccls.	US-PGPUB; USPAT
23	BRS	L23	3	L20 and (metal adj substrate) and (hole or aperture or opening)	US-PGPUB; USPAT
24	BRS	L24	88	257/708.ccls.	EPO; JPO; IBM_TDB
25	BRS	L25	98	257/780.ccls.	EPO; JPO; IBM_TDB
26	BRS	L26	221	257/774.ccls.	EPO; JPO; IBM_TDB
27	BRS	L27	453	257/784.ccls.	EPO; JPO; IBM_TDB